

September 1983 Revised January 2005

MM74HCU04 **Hex Inverter**

General Description

The MM74HCU04 inverters utilize advanced silicon-gate CMOS technology to achieve operating speeds similar to LS-TTL gates with the low power consumption of standard CMOS integrated circuits.

The MM74HCU04 is an unbuffered inverter. It has high noise immunity and the ability to drive 15 LS-TTL loads. The 74HCU logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to $V_{\mbox{\footnotesize CC}}$ and ground.

Features

- Typical propagation delay: 7 ns
- Fanout of 15 LS-TTL loads
- Quiescent power consumption: 10 µA maximum at room temperature
- Low input current: 1 µA maximum

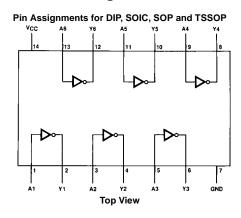
Ordering Code:

Order Number	Package Number	Package Description			
MM74HCU04M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow			
MM74HCU04MX_NL	M14A	Pb-Free 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow			
MM74HCU04SJ	M14D	Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide			
MM74HCU04MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide			
MM74HCU04N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide			
MM74HCU04N_NL	N14A	Pb-Free 14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide			

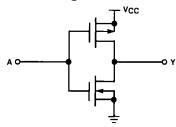
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Pb-Free package per JEDEC J-STD-020B.

Connection Diagram



Schematic Diagram



Absolute Maximum Ratings(Note 1)

(Note 2)

Power Dissipation (P_D)

(Note 3) 600 mW S.O. Package only 500 mW

Lead Temperature (T_L)

(Soldering 10 seconds) 260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temperature Range (T _A)	-40	+85	°C

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -

12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		$T_A = -40 \text{ to } 85^{\circ}\text{C}$ $T_A = -55 \text{ to } 125^{\circ}\text{C}$		Units
•		Conditions	•cc	Тур		Guaranteed L		
V _{IH}	Minimum HIGH Level		2.0V		1.7	1.7	1.7	V
	Input Voltage		4.5V		3.6	3.6	3.6	V
			6.0V		4.8	4.8	4.8	V
V _{IL}	Maximum LOW Level		2.0V		0.3	0.3	0.3	V
	Input Voltage		4.5V		0.8	0.8	0.8	V
			6.0V		1.1	1.1	1.1	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IL}$						
	Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	2.0	1.8	1.8	1.8	V
			4.5V	4.5	4.0	4.0	4.0	V
			6.0V	6.0	5.5	5.5	5.5	V
		$V_{IN} = GND$						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$						
	Output Voltage	$ I_{OUT} \leq 20 \; \mu A$	2.0V	0	0.2	0.2	0.2	V
			4.5V	0	0.5	0.5	0.5	V
			6.0V	0	0.5	0.5	0.5	V
		$V_{IN} = V_{CC}$						
		$ I_{OUT} \le 6.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} \le 7.8 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input	V _{IN} = V _{CC} or GND	6.0V		±0.1	±1.0	±1.0	μΑ
	Current							
I _{CC}	Maximum Quiescent	V _{IN} = V _{CC} or GND	6.0V		2.0	20	40	μΑ
	Supply Current	$I_{OUT} = 0 \mu A$						

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Units
t _{PHL} , t _{PLH}	Maximum Propagation		7	13	ns
	Delay				

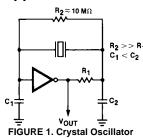
AC Electrical Characteristics

 $V_{CC} = 2.0 \text{V}$ to 6.0 V, $C_L = 50 \text{ pF}$, $t_r = t_f = 6 \text{ ns}$ (unless otherwise specified)

Symbol	Parameter	Conditions	v _{cc}	T _A =25°C		T _A =-40 to 85°C	T _A =-55 to 125°C	Units
Cyllibol	i arameter			Тур	Guaranteed Limits			Oilles
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	49	82	103	120	ns
	Delay		4.5V	9.9	16	21	24	ns
			6.0V	8.4	14	18	20	ns
t _{TLH} , t _{THL}	Maximum Output Rise		2.0V	30	75	95	110	ns
	and Fall Time		4.5V	8	15	19	22	ns
			6.0V	7	13	16	19	ns
C _{PD}	Power Dissipation	(per gate)		90				pF
	Capacitance (Note 5)							
C _{IN}	Maximum Input			8	15	15	15	pF
	Capacitance							

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

Typical Applications



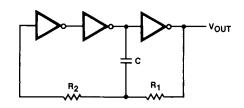
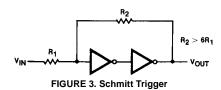


FIGURE 2. Stable RC Oscillator



Physical Dimensions inches (millimeters) unless otherwise noted $\frac{0.335 - 0.344}{(8.509 - 8.738)}$ LEAD NO. 1 IDENT 0.010 MAX (0.254) $\frac{0.150 - 0.157}{(3.810 - 3.988)}$ $\frac{0.053 - 0.069}{(1.346 - 1.753)}$ $\frac{0.010 - 0.020}{(0.254 - 0.508)}$ 8° MAX TYP ALL LEADS $\frac{0.004 - 0.010}{(0.102 - 0.254)}$ SEATING PLANE 0.014 0.008 - 0.010 (0.203 - 0.254) TYP ALL LEADS 0.050 (1.270) TYP $\frac{0.014 - 0.020}{(0.356 - 0.508)} \text{ TYP}$

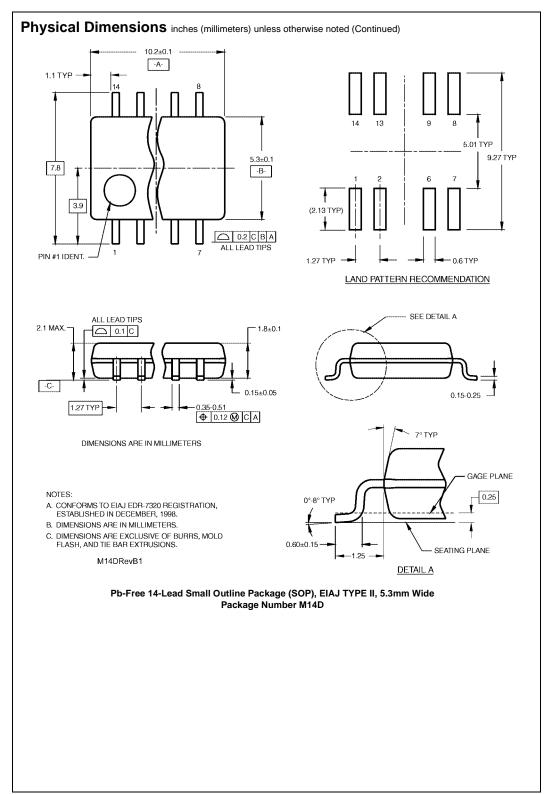
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M14A

0.008 (0.203) TYP

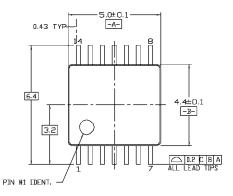
M14A (REV h)

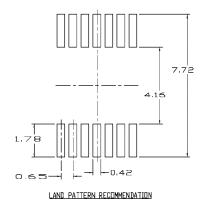
0.016 - 0.050 (0.406 - 1.270) TYP ALL LEADS

0.004 (0.102) ALL LEAD TIPS

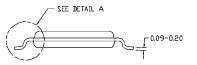


Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





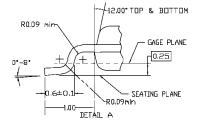
ALL LEAD TIPS $0.90^{+0.15}_{-0.10}$ L2 MAX -C-0.10±0.05 0.19 - 0.30 | \$\Phi\$ | 0.13\mathbb{A} | B\mathbb{S} | C\mathbb{S} |



NOTES:

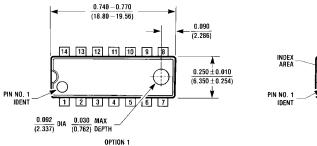
- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB_ REF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982

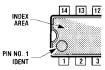
MTC14revD



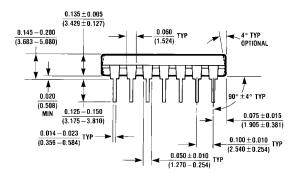
14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

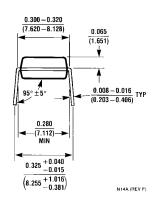
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





OPTION 02





14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

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